

STS4NF100

N-CHANNEL 100V - 0.065 Ω - 4A SO-8 STripFETTM II POWER MOSFET

TYPE	V _{DSS}	RDS(on)	ΙD	
STS4NF100	100 V	<0.070 Ω	4 A	

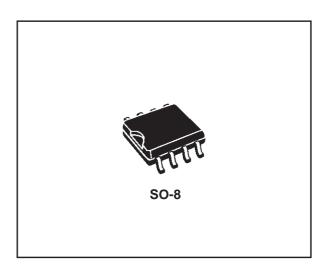
- TYPICAL $R_{DS}(on) = 0.065 \Omega$
- EXCEPTIONAL dv/dt CAPABILITY
- 100 % AVALANCHE TESTED
- APPLICATION ORIENTED CHARACTERIZATION



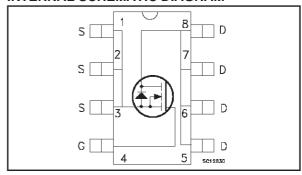
This MOSFET series realized with STMicroelectronics unique STripFET process has specifically been designed to minimize input capacitance and gate charge. It is therefore suitable as primary switch in advanced highefficiency, high-frequency isolated DC-DC converters for Telecom and Computer applications. It is also intended for any applications with low gate drive requirements.

APPLICATIONS

- HIGH-EFFICIENCY DC-DC CONVERTERS
- UPS AND MOTOR CONTROL



INTERNAL SCHEMATIC DIAGRAM



ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit				
V _{DS}	Drain-source Voltage (V _{GS} = 0)	100	V				
V_{DGR}	Drain-gate Voltage (R _{GS} = 20 k Ω)	100	V				
V _{GS}	Gate- source Voltage	± 20	V				
I _D	Drain Current (continuos) at T _C = 25°C Drain Current (continuos) at T _C = 100°C	4 2.5	A A				
I _{DM} (•)	Drain Current (pulsed)	16	А				
P _{tot}	Total Dissipation at T _C = 25°C	2.5	W				

(•) Pulse width limited by safe operating area.

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THERMAL DATA

T _j	(*)Thermal Resistance Junction-ambient Thermal Operating Junction-ambient Storage Temperature	Single Operatio	50 -55 to 150 -55 to 150	°C/W °C °C	
Istg	Storage Temperature		-55 to 150	ا "د	

^(*) Mounted on FR-4 board (t [10 sec.)

ELECTRICAL CHARACTERISTICS (T_{case} = 25 °C unless otherwise specified)

OFF

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0$	100			V
I _{DSS}	Zero Gate Voltage Drain Current (V _{GS} = 0)	$V_{DS} = Max Rating$ $V_{DS} = Max Rating T_C = 125^{\circ}C$			1 10	μA μA
Igss	Gate-body Leakage Current (V _{DS} = 0)	V _{GS} = ± 20 V			±100	nA

ON (*)

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$	$I_D = 250 \mu\text{A}$	2	3	4	V
R _{DS(on)}	Static Drain-source On Resistance	V _{GS} = 10 V	I _D = 2 A		0.065	0.070	Ω

DYNAMIC

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
g _{fs} (*)	Forward Transconductance	$V_{DS}>I_{D(on)}xR_{DS(on)max}I_{D}=2$ A		10		S
C _{iss} C _{oss} C _{rss}	Input Capacitance Output Capacitance Reverse Transfer Capacitance	V _{DS} = 25V, f = 1 MHz, V _{GS} = 0		870 125 52		pF pF pF

ELECTRICAL CHARACTERISTICS (continued)

SWITCHING ON

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
td(on) t _r	Turn-on Delay Time Rise Time	$\begin{aligned} &V_{DD} = 50 \text{ V} & I_D = 4 \text{ A} \\ &R_G = 4.7 \Omega & V_{GS} = 10 \text{ V} \\ &(\text{Resistive Load, Figure 3}) \end{aligned}$		58 45		ns ns
Q _g Q _{gs} Q _{gd}	Total Gate Charge Gate-Source Charge Gate-Drain Charge	V _{DD} = 80V I _D = 4A V _{GS} =10V		30 6 10	41	nC nC nC

SWITCHING OFF

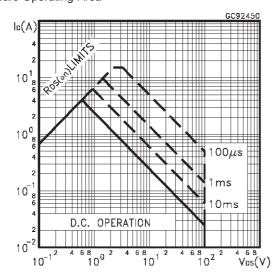
Sym	bol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
t _{d(c}	ff)	Turn-off Delay Time Fall Time	$V_{DD} = 50 \text{ V}$ $R_G = 4.7\Omega$, (Resistive Load	$I_D = 4 A$ $V_{GS} = 10 V$ I, Figure 3)		49 17		ns ns

SOURCE DRAIN DIODE

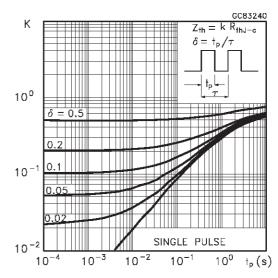
Symbol	Parameter	Test Conditions		Тур.	Max.	Unit
I _{SD} I _{SDM} (•)	Source-drain Current Source-drain Current (pulsed)				4 16	A A
V _{SD} (*)	Forward On Voltage	$I_{SD} = 4 A$ $V_{GS} = 0$			1.2	V
t _{rr} Q _{rr} IRRM	Reverse Recovery Time Reverse Recovery Charge Reverse Recovery Current	$\begin{split} I_{SD} = 4 & \text{A} & \text{di/dt} = 100 \text{A}/\mu \text{s} \\ V_{DD} = 30 & \text{V} & \text{T}_j = 150^{\circ} \text{C} \\ \text{(see test circuit, Figure 5)} \end{split}$		100 375 7.5		ns nC A

^(*)Pulsed: Pulse duration = 300 μs, duty cycle 1.5 %. (•)Pulse width limited by safe operating area.

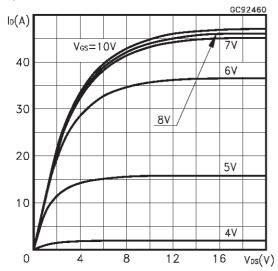
Safe Operating Area



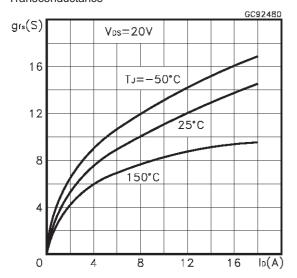
Thermal Impedance



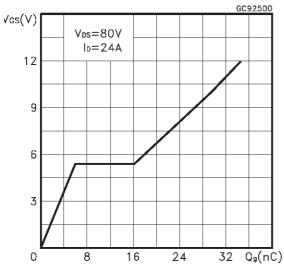
Output Characteristics



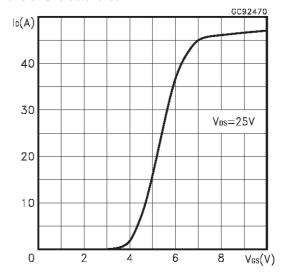
Transconductance



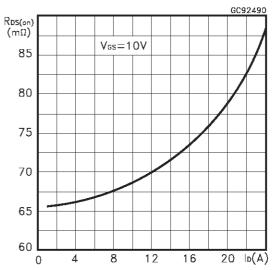
Gate Charge vs Gate-source Voltage



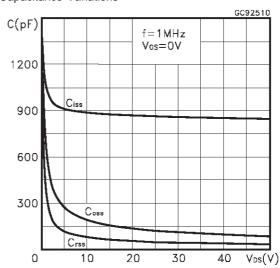
Transfer Characteristics



Static Drain-source On Resistance

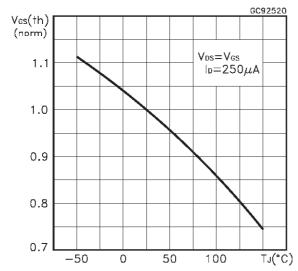


Capacitance Variations

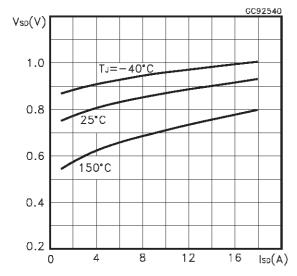


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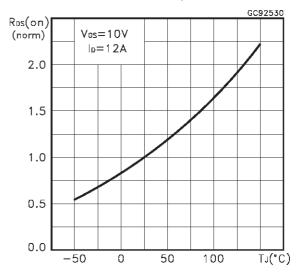
Normalized Gate Threshold Voltage vs Temperature



Source-drain Diode Forward Characteristics



Normalized on Resistance vs Temperature



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Fig. 1: Unclamped Inductive Load Test Circuit

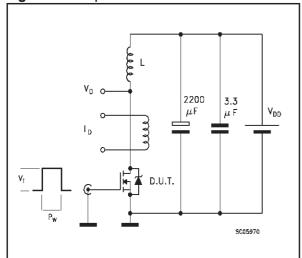


Fig. 3: Switching Times Test Circuits For Resistive Load

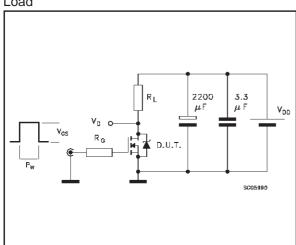


Fig. 5: Test Circuit For Inductive Load Switching And Diode Recovery Times

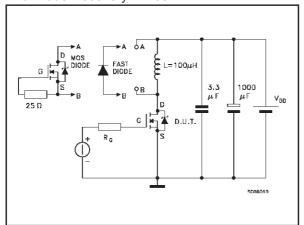


Fig. 2: Unclamped Inductive Waveform

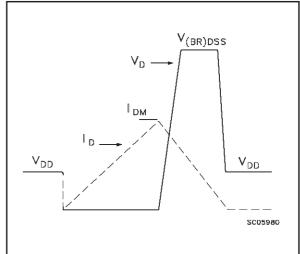
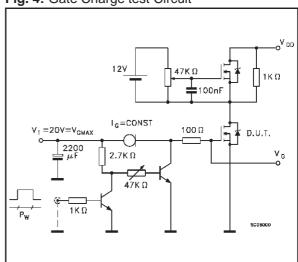
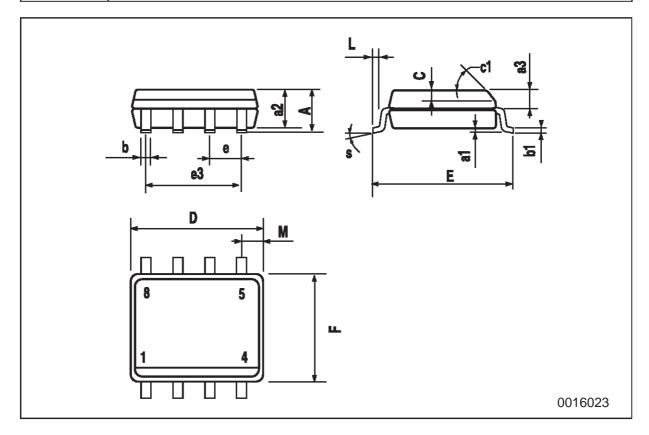


Fig. 4: Gate Charge test Circuit



SO-8 MECHANICAL DATA

DIM.		mm		inch					
DIIVI.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.			
Α			1.75			0.068			
a1	0.1		0.25	0.003		0.009			
a2			1.65			0.064			
аЗ	0.65		0.85	0.025		0.033			
b	0.35		0.48	0.013		0.018			
b1	0.19		0.25	0.007		0.010			
С	0.25		0.5	0.010		0.019			
c1			45	(typ.)					
D	4.8		5.0	0.188		0.196			
Е	5.8		6.2	0.228		0.244			
е		1.27			0.050				
e3		3.81			0.150				
F	3.8		4.0	0.14		0.157			
L	0.4		1.27	0.015		0.050			
М			0.6			0.023			
S		8 (max.)							



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